

Title of Change:	Update to SQFP48 & SQFP64 Package Small Tray Products change in Minimum Order Quantity (MOQ)				
Proposed first ship date:	27 November 2015				
Contact information:	Contact your local ON Semiconductor Sales Office or <Takeshi2.Hoshino@onsemi.com> <Hiroshi2.Kobayashi@onsemi.com>				
Samples:	Contact your local ON Semiconductor Sales Office				
Additional Reliability Data:	Contact your local ON Semiconductor Sales Office				
Type of notification:	ON Semiconductor will consider this change accepted, unless an inquiry is made in writing within 30 days of delivery of this notice. To do so, contact <PCN.Support@onsemi.com>.				
Change category:	☐ Wafer Fab Change ☐ Assembly Change ☐ Test Change ☒ Other: <u>packing method</u>				
Change Sub-Category(s): ☐ Manufacturing Site Change/Addition ☐ Manufacturing Process Change ☐ Material Change ☐ Product specific change ☐ Datasheet/Product Doc change ☐ Shipping/Packaging/Marking ☒ Other: <u>packing method</u>					
Sites Affected: ☐ All site(s) ☐ not applicable ☒ ON Semiconductor site(s) : ON Tarlac City, Philippines ☐ External Foundry/Subcon site(s)					
Description and Purpose: This UN is issued to inform customers of the following changes on FPCN20989 series: - List of Contact persons for FPCN20989 series will now be just: Takeshi2.Hoshino@onsemi.com and Hiroshi2.Kobayashi@onsemi.com - MOQ information corrections: <table border="1" style="margin-left: auto; margin-right: auto; border-collapse: collapse;"> <thead> <tr> <th style="padding: 5px;">MOQ :OLD Packing method</th><th style="padding: 5px;">MOQ:NEW Packing method</th></tr> </thead> <tbody> <tr> <td style="padding: 5px;">500 pcs(50pcs/trayx10trays)</td><td style="padding: 5px;">1250pcs(250pcs/trayx5trays)</td></tr> </tbody> </table> The change in Minimum Packing Quantity (MPQ) will be implemented. The dimensions of the tray will be large as well as the packing material. Please see the difference between attached detailed documents of MOQ before and after change.  SQ48_NEW.pdf  SQ48_OLD.pdf To access file attachments on pdf copy of PCN, please be guided by the steps below: 1. Download pdf copy of the PCN to your computer 2. Open the downloaded pdf copy of the PCN 3. Click on the paper clip icon available on the menu provided in the left/bottom portion of the screen to reveal the Attachment field 4. Then click on the attached file/s		MOQ :OLD Packing method	MOQ:NEW Packing method	500 pcs(50pcs/trayx10trays)	1250pcs(250pcs/trayx5trays)
MOQ :OLD Packing method	MOQ:NEW Packing method				
500 pcs(50pcs/trayx10trays)	1250pcs(250pcs/trayx5trays)				



List of Affected Standard Parts:

Part Number	Qualification Vehicle
LC75411WS-E	LC75836WS-E
LC75411WS-UF-E	
LC75833WHS-E	
LC75834WHS-E	
LC75835W-E	
LC75836W-E	
LC75836WH-E	
LC75836WS-E	
LC75836WS-T-E	
LC75841PE-H	
LC75841PES-H	
LC75863W-E	
LC75863WS-E	

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If no Customer Part Number is on file, the CPN Part Number is marked “CPN Unassigned”.

MPN	CPN	Company Name	Company Code	Division Name	Division Code
LC75836WH-E	CPN Unassigned	ebv elektronik	ekEBV ELEKTRONIK GMBH & CO KG		EXATZ
LC75836WH-E	CPN Unassigned	ebv elektronik	ek	EBV ELEKTRONIK GMBH	EVBKZ